

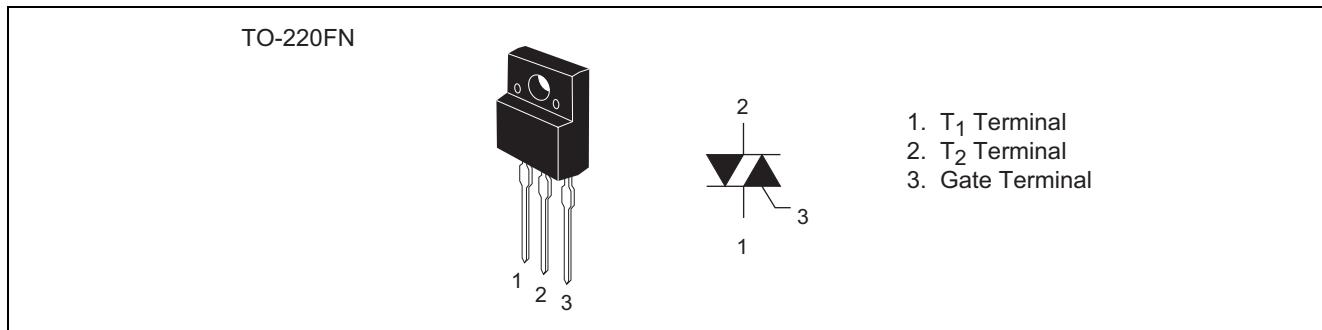


# BCR16KM-12LA

## Features

- $I_{T(RMS)}$  : 16 A
- $V_{DRM}$  : 600 V
- $I_{FGTI}$ ,  $I_{RGTI}$ ,  $I_{RGTI\text{III}}$  : 30 mA (20 mA)<sup>Note5</sup>
- Viso : 2000 V
- Insulated Type
- Planar Passivation Type
- UL Recognized : Yellow Card No. E223904  
File No. E80271

## Outline



## Applications

Switching mode power supply, washing machine, copying machine, motor control, heater control, and other general purpose control applications

## Maximum Ratings

Parameter	Symbol	Voltage class		Unit
		12		
Repetitive peak off-state voltage <sup>Note1</sup>	$V_{DRM}$	600		V
Non-repetitive peak off-state voltage <sup>Note1</sup>	$V_{DSM}$	720		V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{\text{TRMS}}$	16	A	Commercial frequency, sine full wave 360° conduction, $T_c = 73^\circ\text{C}$
Surge on-state current	$I_{\text{TSM}}$	160	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
$I^2t$ for fusing	$I^2t$	106.5	$\text{A}^2\text{s}$	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	$P_{\text{GM}}$	5	W	
Average gate power dissipation	$P_{\text{G(AV)}}$	0.5	W	
Peak gate voltage	$V_{\text{GM}}$	10	V	
Peak gate current	$I_{\text{GM}}$	2	A	
Junction temperature	$T_j$	-40 to +125	$^\circ\text{C}$	
Storage temperature	$T_{\text{stg}}$	-40 to +125	$^\circ\text{C}$	
Mass	—	2.0	g	Typical value
Isolation voltage	$V_{\text{iso}}$	2000	V	$T_a = 25^\circ\text{C}$ , AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

## Electrical Characteristics

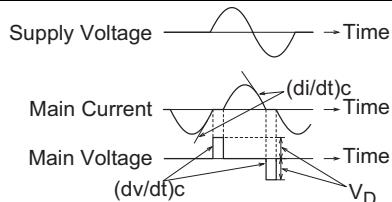
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	$I_{\text{DRM}}$	—	—	2.0	mA	$T_j = 125^\circ\text{C}$ , $V_{\text{DRM}}$ applied
On-state voltage	$V_{\text{TM}}$	—	—	1.5	V	$T_c = 25^\circ\text{C}$ , $I_{\text{TM}} = 25$ A, Instantaneous measurement
Gate trigger voltage <sup>Note2</sup>	I	$V_{\text{FGTI}}$	—	1.5	V	$T_j = 25^\circ\text{C}$ , $V_D = 6$ V, $R_L = 6$ $\Omega$ , $R_G = 330$ $\Omega$
	II	$V_{\text{RGTI}}$	—	1.5	V	
	III	$V_{\text{RGTI}}_{\text{III}}$	—	1.5	V	
Gate trigger current <sup>Note2</sup>	I	$I_{\text{FGTI}}$	—	30 <sup>Note5</sup>	mA	$T_j = 25^\circ\text{C}$ , $V_D = 6$ V, $R_L = 6$ $\Omega$ , $R_G = 330$ $\Omega$
	II	$I_{\text{RGTI}}$	—	30 <sup>Note5</sup>	mA	
	III	$I_{\text{RGTI}}_{\text{III}}$	—	30 <sup>Note5</sup>	mA	
Gate non-trigger voltage	$V_{\text{GD}}$	0.2	—	—	V	$T_j = 125^\circ\text{C}$ , $V_D = 1/2$ $V_{\text{DRM}}$
Thermal resistance	$R_{\text{th(j-c)}}$	—	—	2.9	$^\circ\text{C/W}$	Junction to case <sup>Note3</sup>
Critical-rate of rise of off-state commutating voltage <sup>Note4</sup>	$(dv/dt)c$	10	—	—	V/ $\mu$ s	$T_j = 125^\circ\text{C}$

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

3. The contact thermal resistance  $R_{\text{th(c-f)}}$  in case of greasing is  $0.5^\circ\text{C/W}$ .

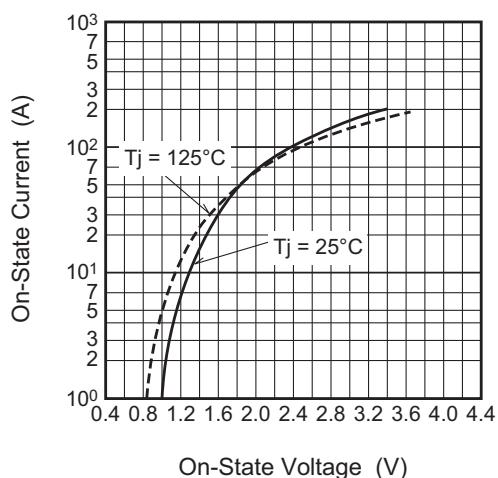
4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

5. High sensitivity ( $I_{\text{GT}} \leq 20$  mA) is also available. ( $I_{\text{GT}}$  item: 1)

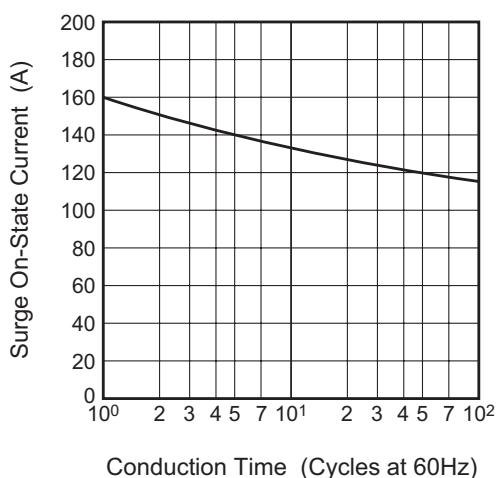
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)c = -8$ A/ms 3. Peak off-state voltage $V_D = 400$ V	

## Performance Curves

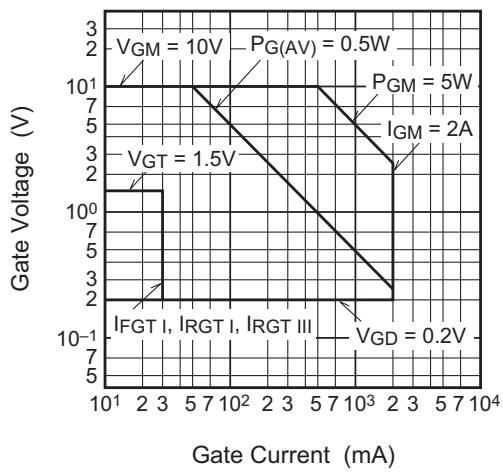
Maximum On-State Characteristics



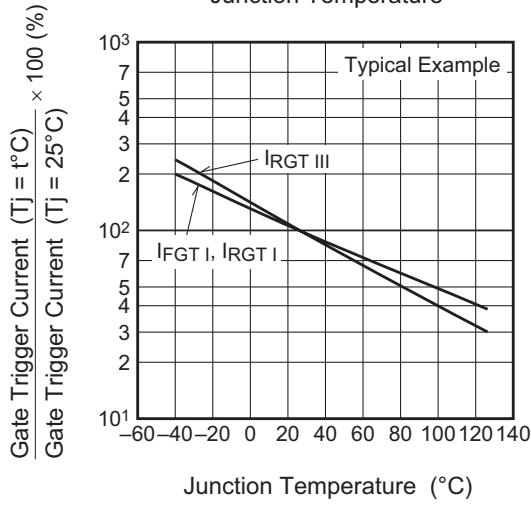
Rated Surge On-State Current



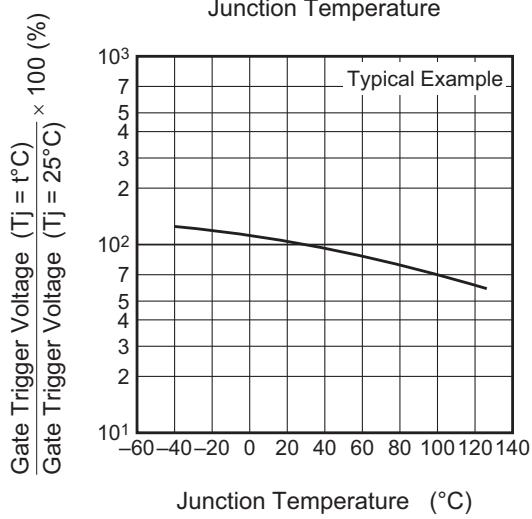
Gate Characteristics (I, II and III)



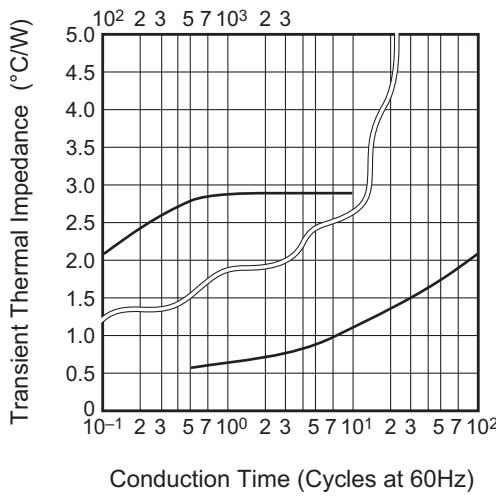
Gate Trigger Current vs. Junction Temperature



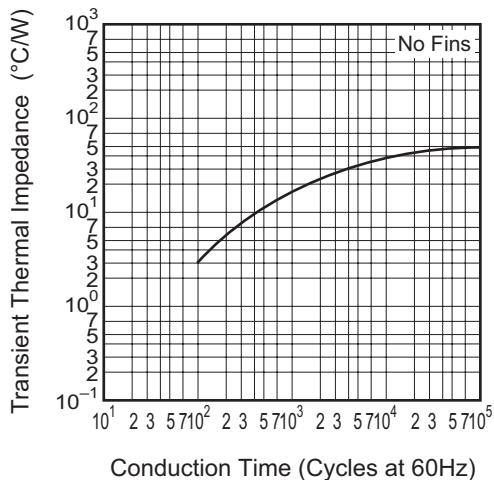
Gate Trigger Voltage vs. Junction Temperature



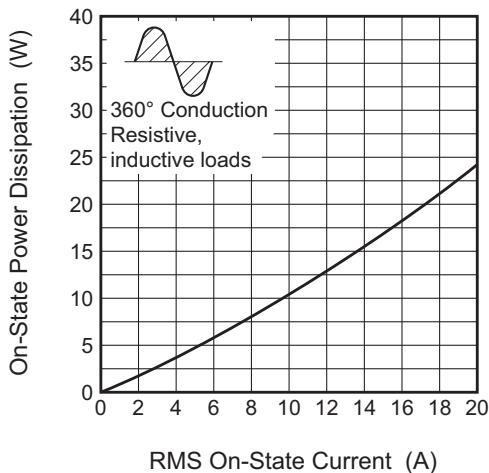
Maximum Transient Thermal Impedance Characteristics (Junction to case)



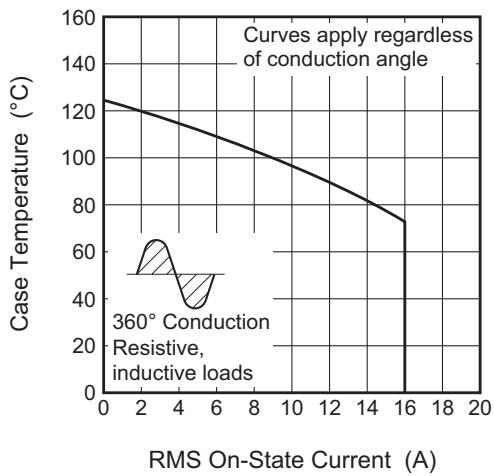
Maximum Transient Thermal Impedance  
Characteristics (Junction to ambient)



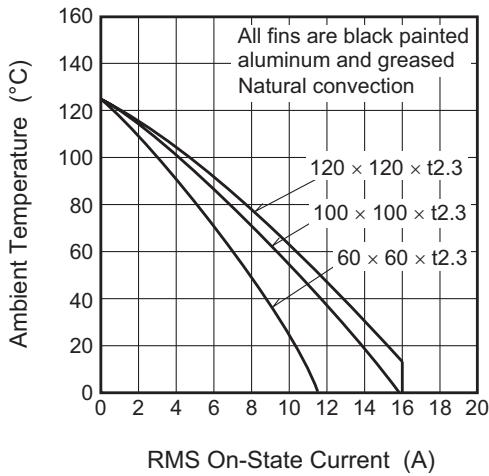
Maximum On-State Power Dissipation



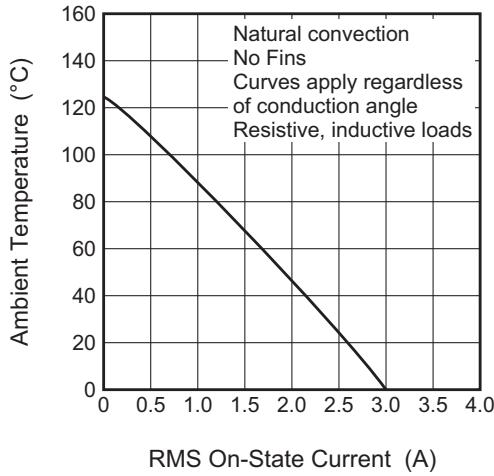
Allowable Case Temperature vs.  
RMS On-State Current



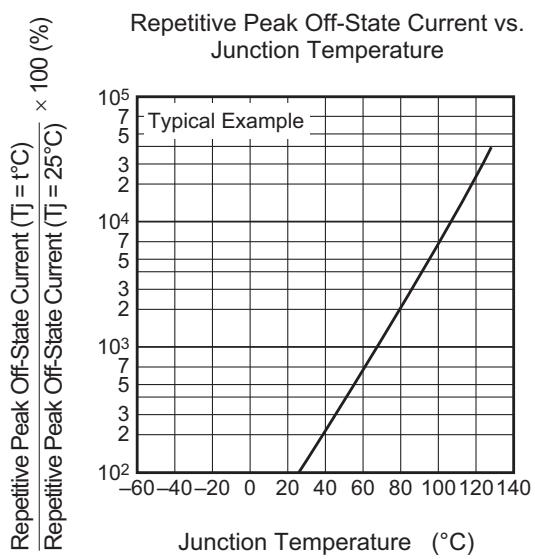
Allowable Ambient Temperature vs.  
RMS On-State Current

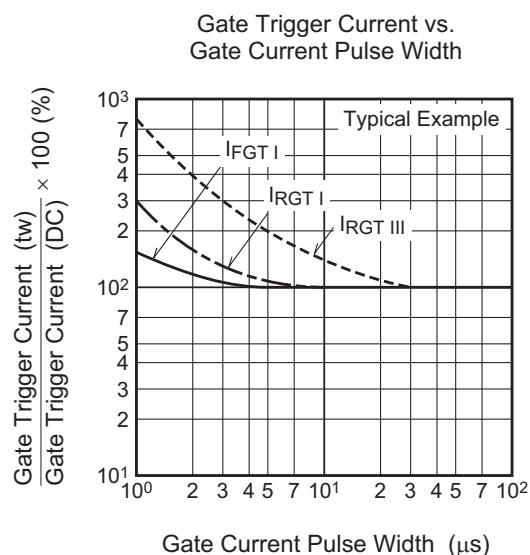
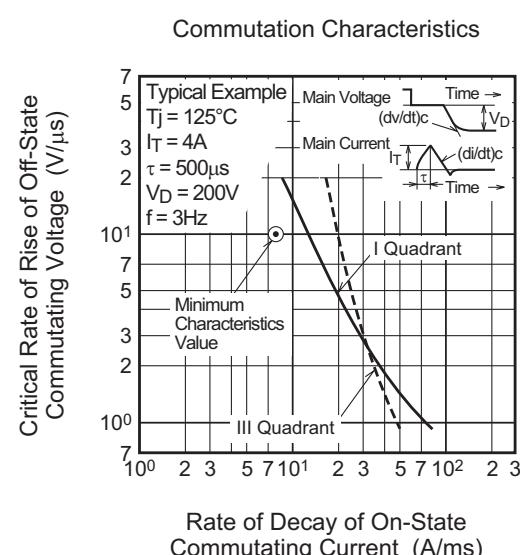
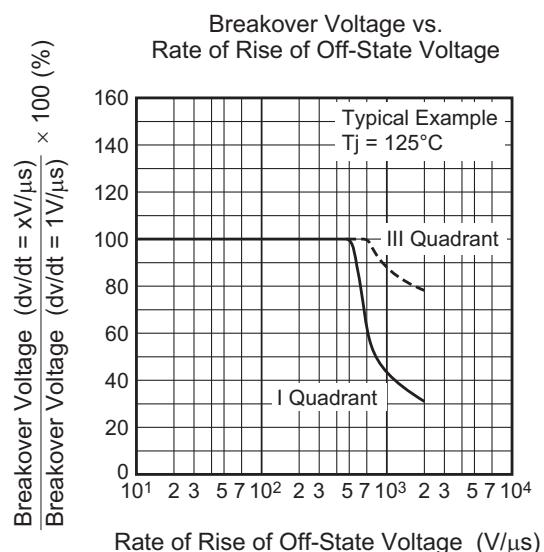
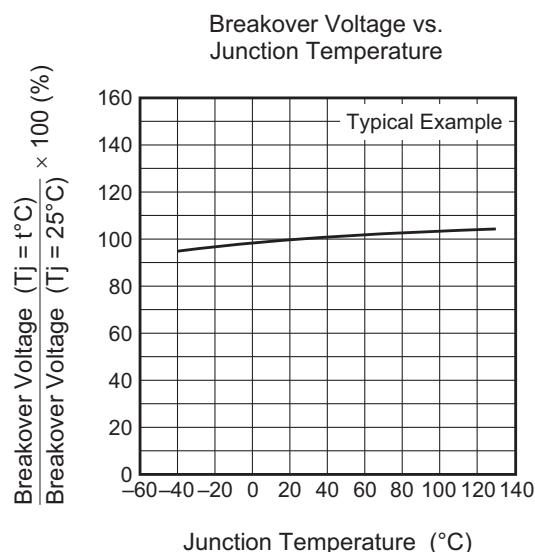
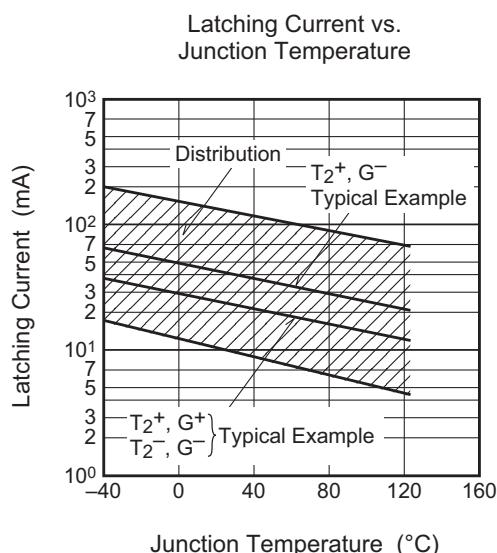
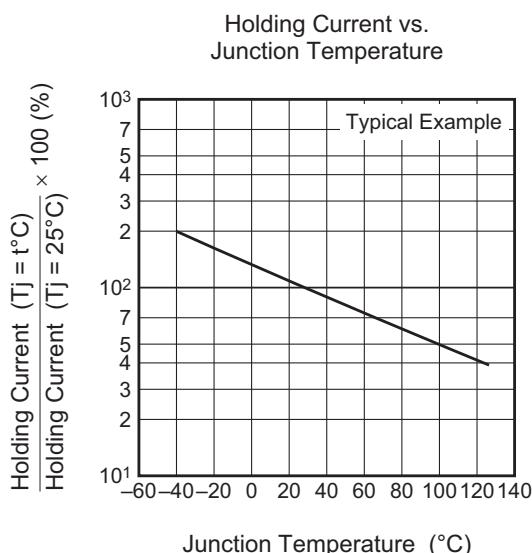


Allowable Ambient Temperature vs.  
RMS On-State Current

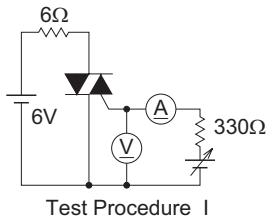


Repetitive Peak Off-State Current vs.  
Junction Temperature

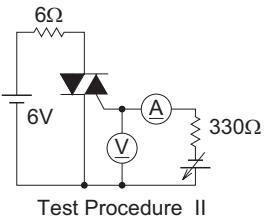




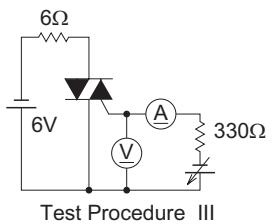
## Gate Trigger Characteristics Test Circuits



Test Procedure I

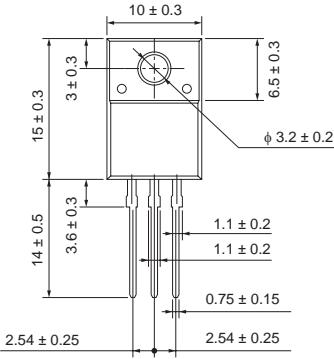
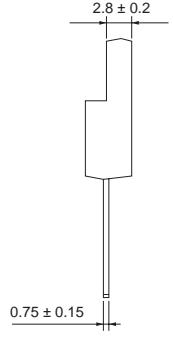
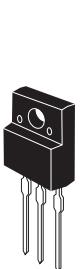
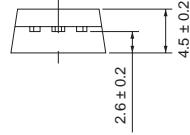


Test Procedure II



Test Procedure III

## Package Dimensions

TO-220FN																																																												
EIAJ Package Code	JEDEC Code	Mass (g) (reference value)	Lead Material																																																									
—	—	2.0	Cu alloy																																																									
 <p>Technical drawing showing the top view and side view dimensions of the TO-220FN package. Top view dimensions include height 15 ± 0.3, width 10 ± 0.3, lead thickness 3 ± 0.3, lead pitch 1.1 ± 0.2, lead height 0.75 ± 0.15, and lead spacing 2.54 ± 0.25. Side view dimensions include lead height 0.75 ± 0.15 and lead thickness 2.54 ± 0.25. A circular feature with diameter <math>\phi 3.2 \pm 0.2</math> is also indicated.</p>	 <p>Technical drawing showing the side cross-section of the TO-220FN package with a height of 2.8 ± 0.2.</p>	 <p>Photograph of the TO-220FN package in its plastic magazine tube.</p>																																																										
 <p>Technical drawing showing the bottom cross-section of the TO-220FN package with a height of 4.5 ± 0.2 and lead thickness 2.6 ± 0.2.</p>				<table border="1"> <thead> <tr> <th>Symbol</th><th colspan="3">Dimension in Millimeters</th></tr> <tr> <th></th><th>Min</th><th>Typ</th><th>Max</th></tr> </thead> <tbody> <tr> <td>A</td><td></td><td></td><td></td></tr> <tr> <td>A<sub>1</sub></td><td></td><td></td><td></td></tr> <tr> <td>A<sub>2</sub></td><td></td><td></td><td></td></tr> <tr> <td>b</td><td></td><td></td><td></td></tr> <tr> <td>D</td><td></td><td></td><td></td></tr> <tr> <td>E</td><td></td><td></td><td></td></tr> <tr> <td>e</td><td></td><td></td><td></td></tr> <tr> <td>x</td><td></td><td></td><td></td></tr> <tr> <td>y</td><td></td><td></td><td></td></tr> <tr> <td>y<sub>1</sub></td><td></td><td></td><td></td></tr> <tr> <td>ZD</td><td></td><td></td><td></td></tr> <tr> <td>ZE</td><td></td><td></td><td></td></tr> </tbody> </table>	Symbol	Dimension in Millimeters				Min	Typ	Max	A				A <sub>1</sub>				A <sub>2</sub>				b				D				E				e				x				y				y <sub>1</sub>				ZD				ZE			
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Note 1) The dimensional figures indicate representative values unless otherwise the tolerance is specified.

## Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	BCR16KM-12LA
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	BCR16KM-12LA-A8

Note : Please confirm the specification about the shipping in detail.